



August 2015

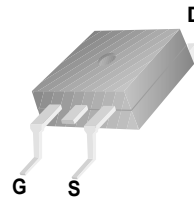
FDB9403L_F085

N-Channel Logic Level PowerTrench[®] MOSFET

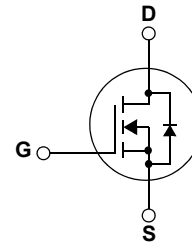
40 V, 110 A, 1.2 mΩ

Features

- Typical $R_{DS(on)}$ = 1.0 mΩ at $V_{GS} = 10V$, $I_D = 80 A$
- Typical $Q_{g(tot)}$ = 186 nC at $V_{GS} = 10V$, $I_D = 80 A$
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101



TO-263
FDB SERIES



Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Integrated Starter/Alternator
- Primary Switch for 12V Systems



For current package drawing, please refer to the Fairchild website at <https://www.fairchildsemi.com/package-drawings/TO/TO263A02.pdf>

MOSFET Maximum Ratings $T_J = 25^\circ C$ unless otherwise noted.

Symbol	Parameter	Conditions	Rated	Units
V_{DSS}	Drain-to-Source Voltage		40	V
V_{GS}	Gate-to-Source Voltage		±20	V
I_D	Drain Current - Continuous ($V_{GS}=10$) (Note 1)	$T_C = 25^\circ C$	110	A
	Pulsed Drain Current	$T_C = 25^\circ C$	See Figure 4	
E_{AS}	Single Pulse Avalanche Energy	(Note 2)	634	mJ
P_D	Power Dissipation		333	W
	Derate Above $25^\circ C$		2.22	W/ $^\circ C$
T_J, T_{STG}	Operating and Storage Temperature		-55 to + 175	$^\circ C$
$R_{\theta JC}$	Thermal Resistance, Junction to Case		0.45	$^\circ C/W$
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	43	$^\circ C/W$

Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting $T_J = 25^\circ C$, $L = 0.3mH$, $I_{AS} = 65A$, $V_{DD} = 40V$ during inductor charging and $V_{DD} = 0V$ during time in avalanche.
- 3: $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design, while $R_{\theta JA}$ is determined by the board design. The maximum rating presented here is based on mounting on a 1 in² pad of 2oz copper.

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB9403L	FDB9403L_F085	D2-PAK(TO-263)	330mm	24mm	800 units

FDB9403L_F085 N-Channel Logic Level PowerTrench[®] MOSFET

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
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Off Characteristics

B_{VDSS}	Drain-to-Source Breakdown Voltage	$I_D = 250\mu\text{A}, V_{GS} = 0\text{V}$	40	-	-	V
I_{DSS}	Drain-to-Source Leakage Current	$V_{DS} = 40\text{V}, T_J = 25^\circ\text{C}$	-	-	1	μA
		$V_{GS} = 0\text{V}, T_J = 175^\circ\text{C}$ (Note 4)	-	-	3	mA
I_{GSS}	Gate-to-Source Leakage Current	$V_{GS} = \pm 20\text{V}$	-	-	± 100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	1.0	1.8	3.0	V
$R_{DS(on)}$	Drain to Source On Resistance	$I_D = 80\text{A}, V_{GS} = 4.5\text{V}$	-	1.2	1.6	m Ω
		$I_D = 80\text{A}, T_J = 25^\circ\text{C}$	-	1.0	1.2	m Ω
		$V_{GS} = 10\text{V}, T_J = 175^\circ\text{C}$ (Note 4)	-	1.7	2.0	m Ω

Dynamic Characteristics

C_{iss}	Input Capacitance	$V_{DS} = 20\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$	-	13500	-	pF
C_{oss}	Output Capacitance		-	4300	-	pF
C_{riss}	Reverse Transfer Capacitance		-	280	-	pF
R_g	Gate Resistance	$f = 1\text{MHz}$	-	2.7	-	Ω
$Q_{g(ToT)}$	Total Gate Charge at 10V	$V_{GS} = 0$ to 10V	-	186	245	nC
$Q_{g(th)}$	Threshold Gate Charge	$V_{GS} = 0$ to 2V				
Q_{gs}	Gate-to-Source Gate Charge	$V_{DD} = 32\text{V}, I_D = 80\text{A}$	-	33	-	nC
Q_{gd}	Gate-to-Drain "Miller" Charge		-	22	-	nC

Switching Characteristics

t_{on}	Turn-On Time	$V_{DD} = 20\text{V}, I_D = 80\text{A}, V_{GS} = 10\text{V}, R_{GEN} = 6\Omega$	-	-	156	ns
$t_{d(on)}$	Turn-On Delay		-	16	-	ns
t_r	Rise Time		-	63	-	ns
$t_{d(off)}$	Turn-Off Delay		-	142	-	ns
t_f	Fall Time		-	107	-	ns
t_{off}	Turn-Off Time		-	-	399	ns

Drain-Source Diode Characteristics

V_{SD}	Source-to-Drain Diode Voltage	$I_{SD} = 80\text{A}, V_{GS} = 0\text{V}$	-	-	1.25	V
		$I_{SD} = 40\text{A}, V_{GS} = 0\text{V}$	-	-	1.2	V
t_{rr}	Reverse-Recovery Time	$I_F = 80\text{A}, dI_{SD}/dt = 100\text{A}/\mu\text{s}, V_{DD} = 32\text{V}$	-	114	171	ns
Q_{rr}	Reverse-Recovery Charge		-	205	328	nC

Note:

4: The maximum value is specified by design at $T_J = 175^\circ\text{C}$. Product is not tested to this condition in production.

Typical Characteristics

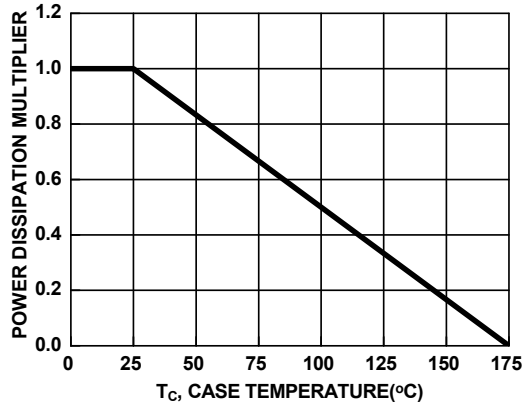


Figure 1. Normalized Power Dissipation vs. Case Temperature

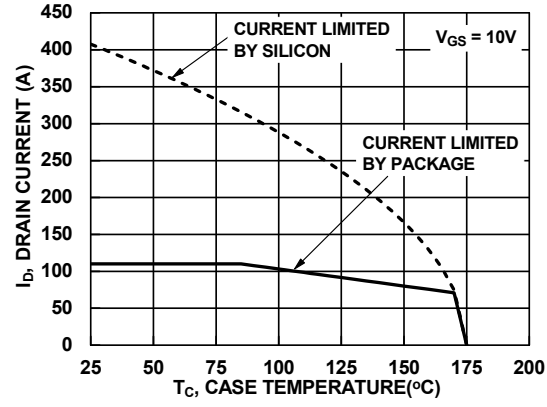


Figure 2. Maximum Continuous Drain Current vs. Case Temperature

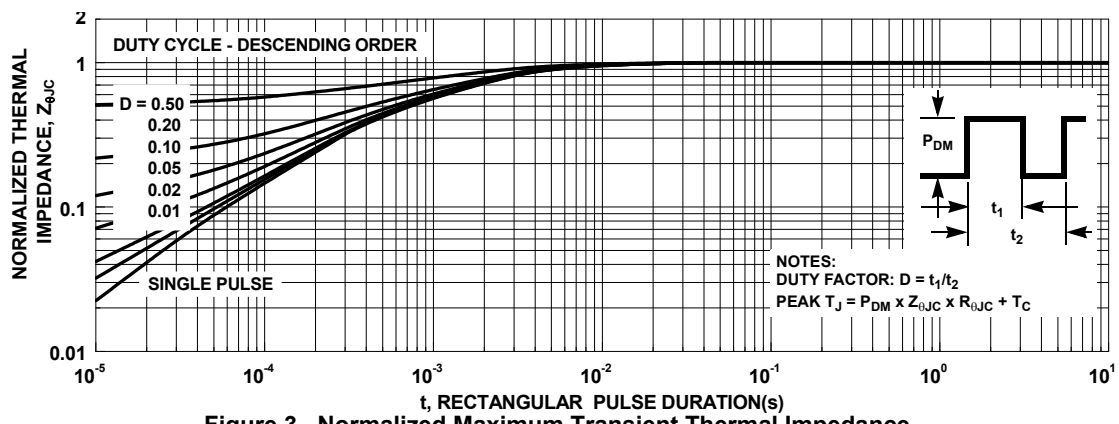


Figure 3. Normalized Maximum Transient Thermal Impedance

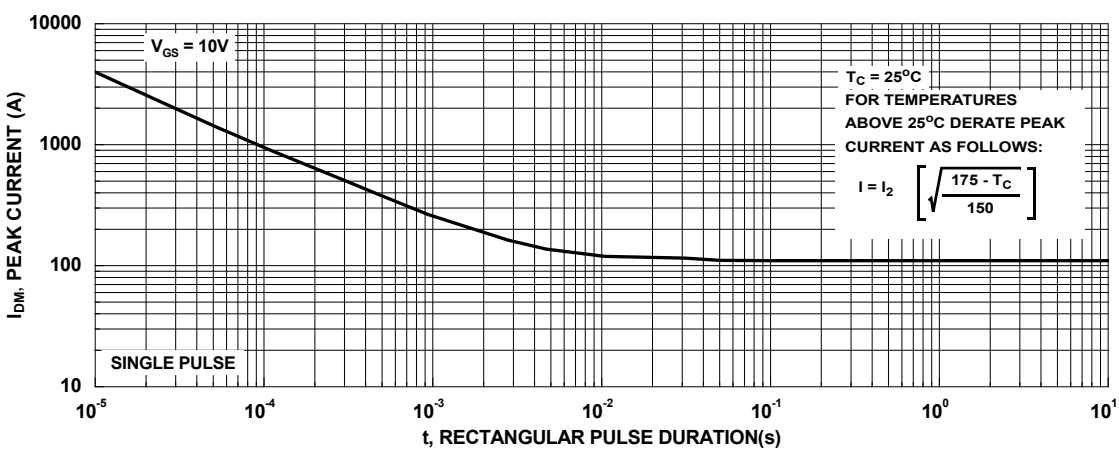


Figure 4. Peak Current Capability

Typical Characteristics

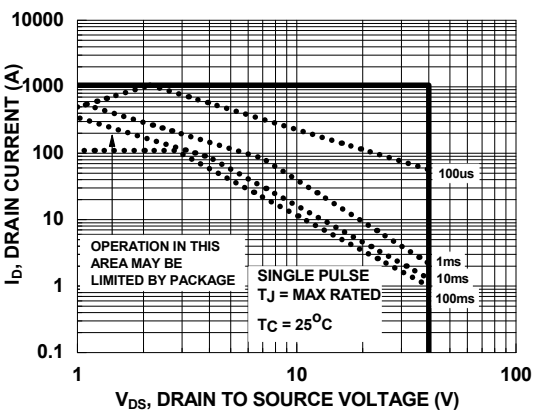


Figure 5. Forward Bias Safe Operating Area

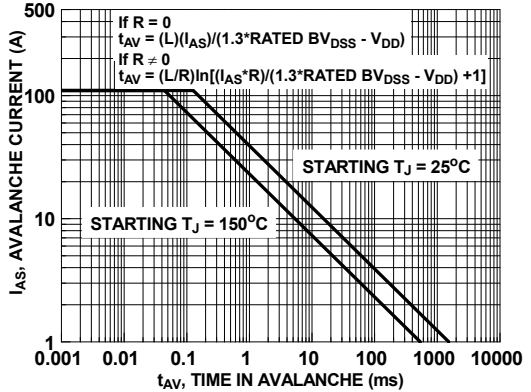


Figure 6. Unclamped Inductive Switching Capability
NOTE: Refer to Fairchild Application Notes AN7514 and AN7515

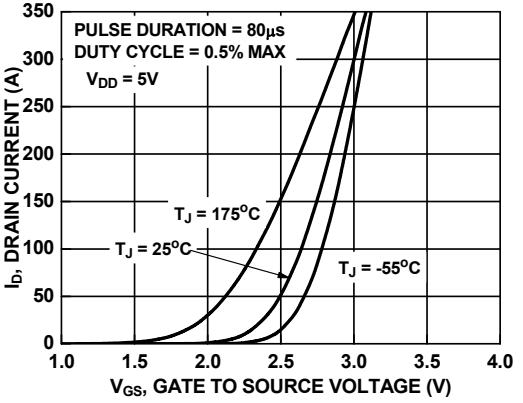


Figure 7. Transfer Characteristics

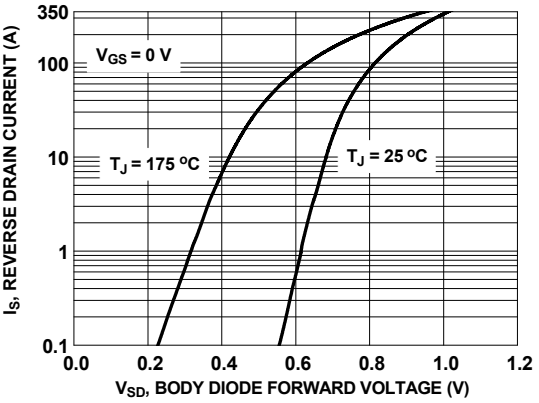


Figure 8. Forward Diode Characteristics

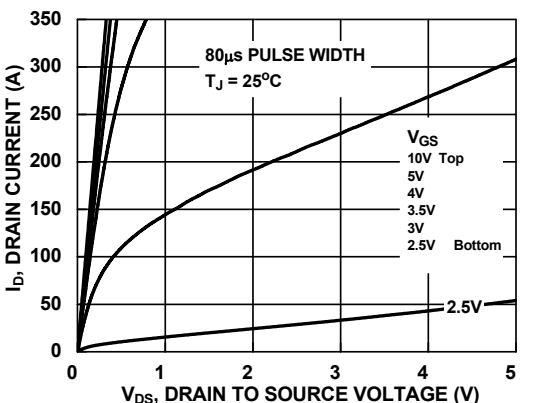


Figure 9. Saturation Characteristics

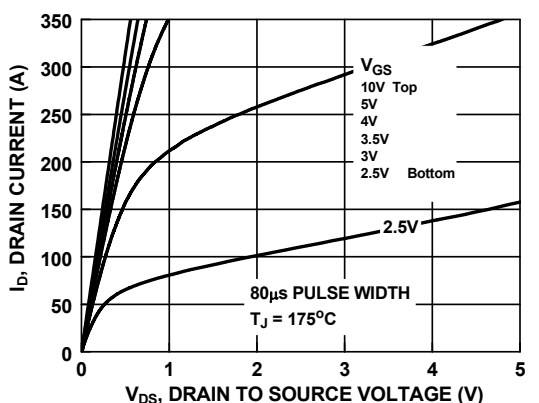


Figure 10. Saturation Characteristics

Typical Characteristics

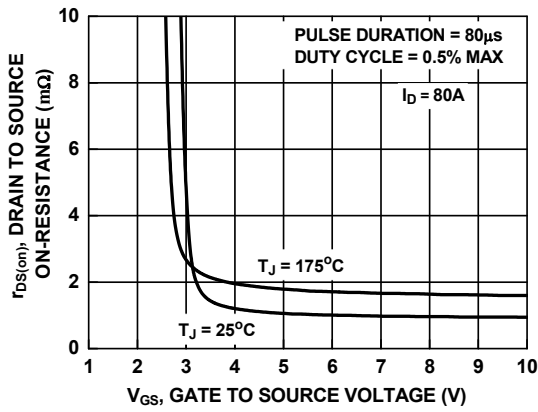


Figure 11. $R_{DS(on)}$ vs. Gate Voltage

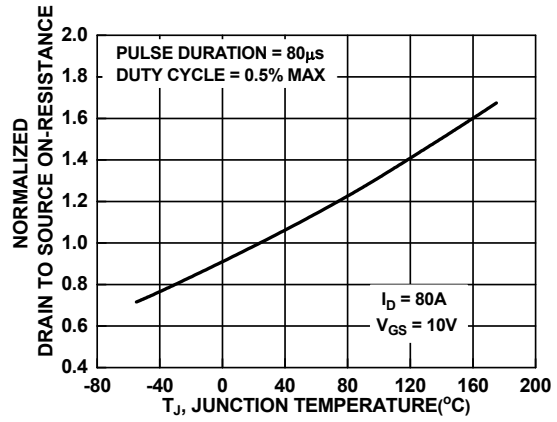


Figure 12. Normalized $R_{DS(on)}$ vs. Junction Temperature

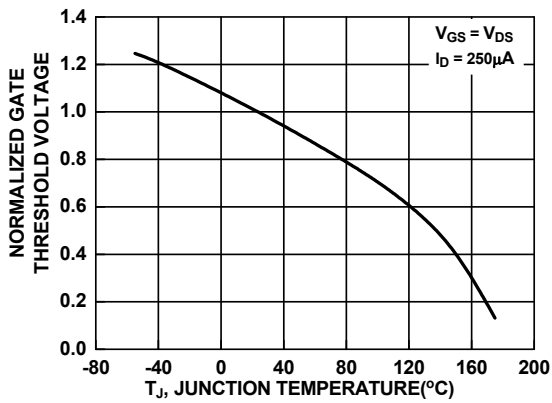


Figure 13. Normalized Gate Threshold Voltage vs. Temperature

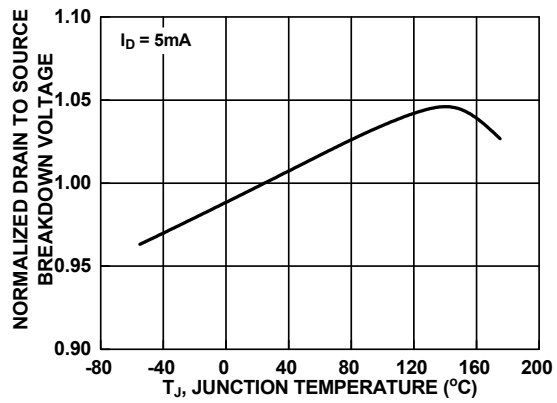


Figure 14. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

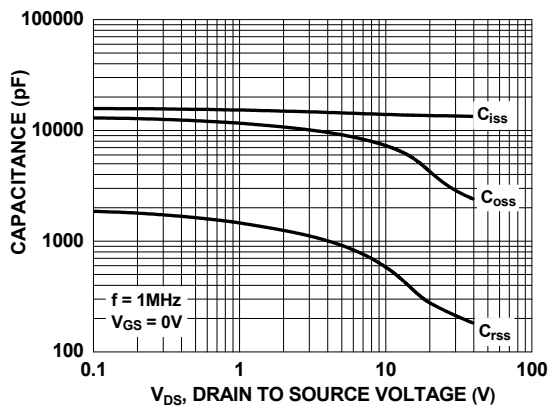


Figure 15. Capacitance vs. Drain to Source Voltage

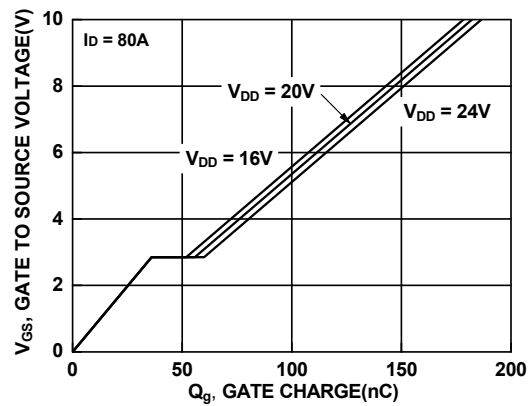
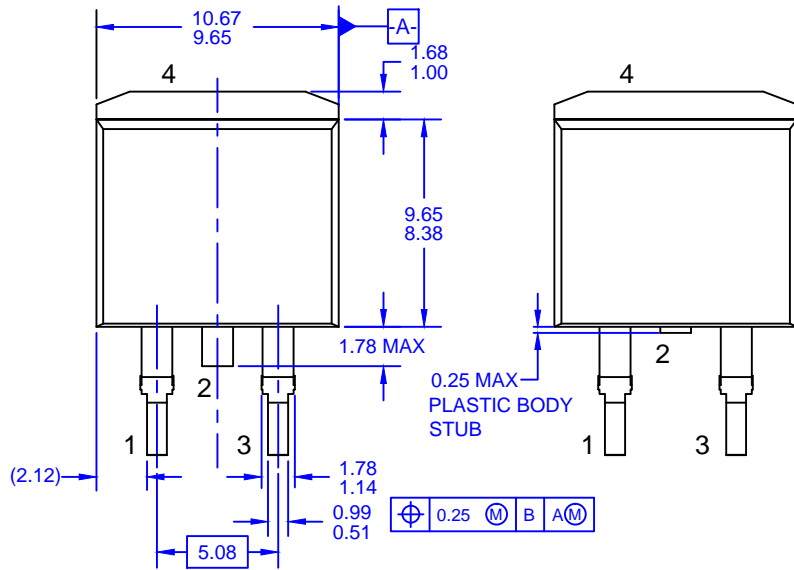
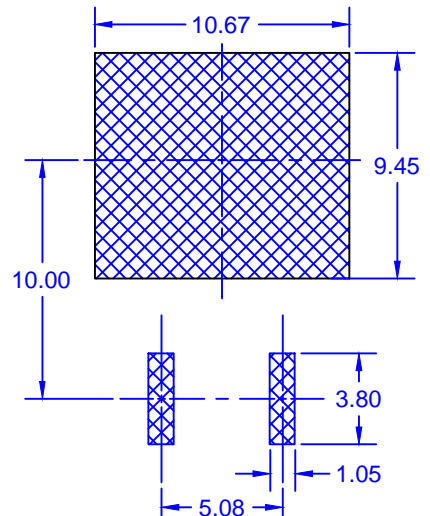


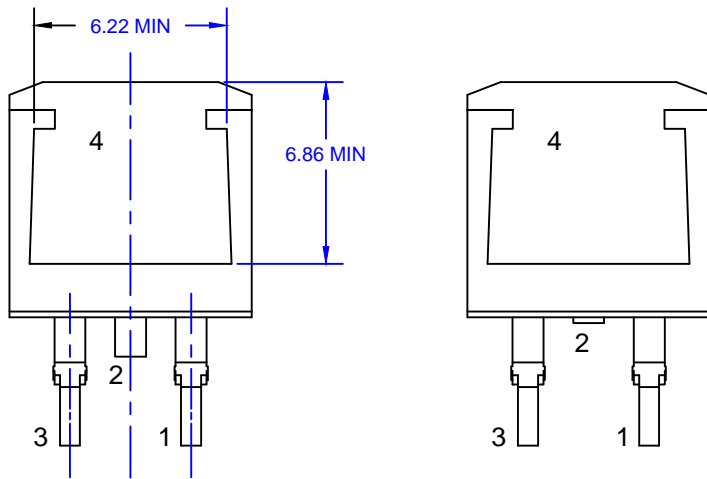
Figure 16. Gate Charge vs. Gate to Source Voltage



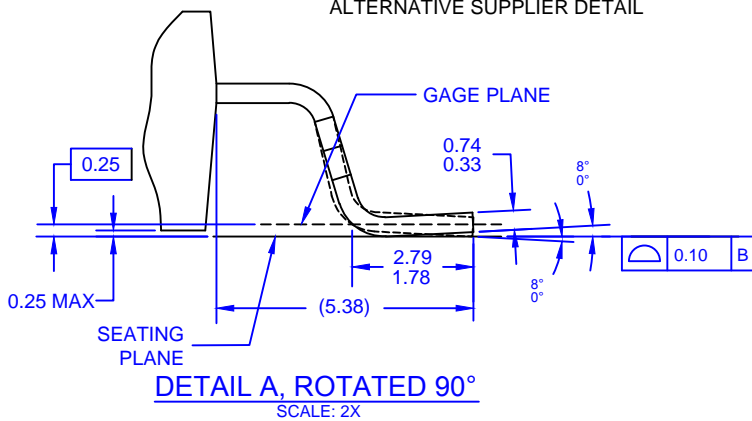
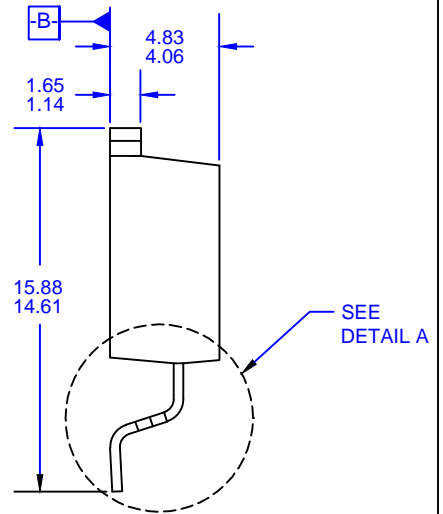
FRONT VIEW - DIODE PRODUCTS VERSION
ALTERNATIVE SUPPLIER DETAIL



LAND PATTERN RECOMMENDATION
UNLESS NOTED, ALL DIMS TYPICAL



BACK VIEW - DIODE PRODUCTS VERSION
ALTERNATIVE SUPPLIER DETAIL



DETAIL A, ROTATED 90°
SCALE: 2X

NOTES: UNLESS OTHERWISE SPECIFIED

- A) ALL DIMENSIONS ARE IN MILLIMETERS.
- B) REFERENCE JEDEC, TO-263, VARIATION AB.
- C) DIMENSIONING AND TOLERANCING PER ASME Y14.5 - 2009.
- D) LOCATION OF THE PIN HOLE MAY VARY (LOWER LEFT CORNER, LOWER CENTER AND CENTER OF THE PACKAGE).
- E) LANDPATTERN RECOMMENDATION PER IPC TO254P1524X482-3N
- F) FILENAME: TO263A02REV8





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Definition of Terms

Datasheet Identification	Product Status	Definition
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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